# onsemi

## **Schottky Rectifier**

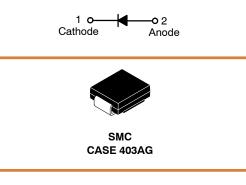
### SS32 - S310

#### Description

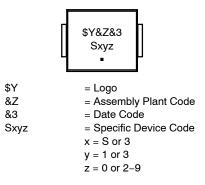
The SS32–S310 series includes a high–efficiency, low power loss, general–propose Schottky rectifiers. The clipbonded leg structure provides high thermal performance and low electrical resistance. These rectifiers are suited for free wheeling, secondary rectification, and reverse polarity protection applications.

#### Features

- Metal to Silicon Rectifiers, Majority Carrier Conduction
- Low–Forward Voltage Drop
- Easy Pick and Place
- High–Surge Current Capability
- This Device is Pb-Free and Halide Free



#### MARKING DIAGRAM



#### ORDERING INFORMATION

Device	Package	Shipping <sup>†</sup>
SS32 SS33 SS34 SS35 SS36 SS38 SS39 S310	SMC (Pb-Free, Halide-Free)	3000 / Tape & Reel

+ For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

		Value								
Symbol	Parameter	SS32	SS33	SS34	SS35	SS36	SS38	SS39	S310	Units
V <sub>RRM</sub>	Maximum Repetitive Reverse Voltage	20	30	40	50	60	80	90	100	V
I <sub>F(AV)</sub>	Maximum Average Forward Current at T <sub>A</sub> = 75°C	3.0							A	
I <sub>FSM</sub>	Non-Repetitive Peak Forward Surge Current: 8.3 ms Single Half-Sine Wave	100						А		
dV/dt	Maximum Voltage Rate of Change	10000					V/μS			
T <sub>STG</sub>	Storage Temperature Range	Temperature Range -55 to +150					°C			
ТJ	Operating Junction Temperature -55 to +150						°C			

#### **ABSOLUTE MAXIMUM RATINGS** Values are at $T_A = 25^{\circ}C$ unless otherwise noted.

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

#### THERMAL CHARACTERISTICS

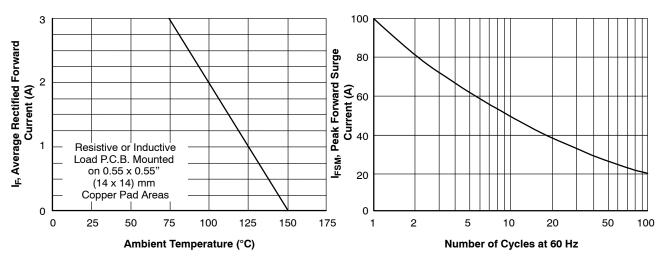
Symbol	Parameter	Value	Unit
PD	Power Dissipation	2.27	W
$R_{\thetaJA}$	Thermal Resistance, Junction to Ambient (Note 1)	55	°C/W
$R_{\theta JL}$	Thermal Resistance, Junction to Lead	17	°C/W

1. Device mounted on FE-4 PCB 0.55 x 0.55 inch (14 x 14 mm).

### **ELECTRICAL CHARACTERISTICS** Values are at $T_A = 25^{\circ}C$ unless otherwise noted.

			Value								
Symbol	Parameter	Test Conditions	SS32	SS33	SS34	SS35	SS36	SS38	SS39	S310	Units
V <sub>F</sub>	Forwarded Voltage	I <sub>F</sub> = 3.0 A	500			750		850			mV
I <sub>R</sub>	Reverse Current at Rated $V_R$	$T_A = 25^{\circ}C$	0.5					mA			
		$T_A = 100^{\circ}C$	20			10					

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

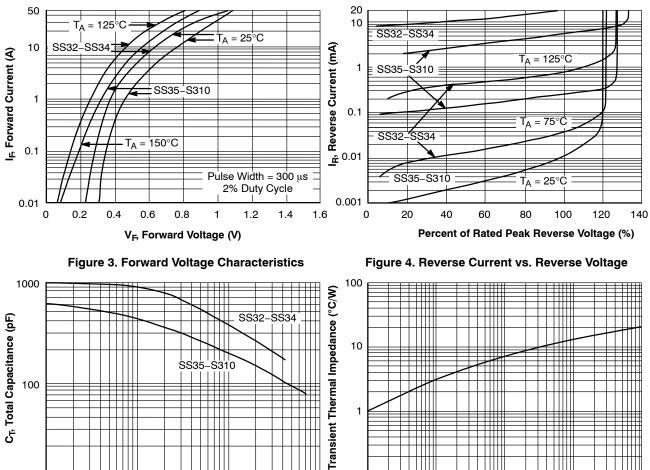


#### **TYPICAL CHARACTERISTICS**



Figure 1. Forward Current Derating Curve





100

Figure 5. Total Capacitance

V<sub>R</sub>, Reverse Voltage (V)

1

-S310

10

SS35

100

10

0.1

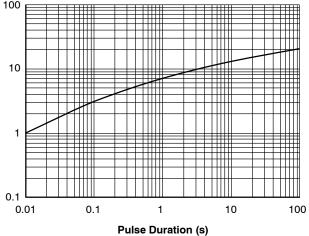


Figure 6. Thermal Impedance Characteristics

2.45

1.90



SMC CASE 403AG **ISSUE O** DATE 31 AUG 2016 8.15 В 7.75 1.96 3.27 6.25 3.39 /B 2.75 5.55 6.81  $\oplus$ (M) 0.13 С В А LAND PATTERN RECOMMENDATION 7.15 Α 6.60 **TOP VIEW 8** ° R0.15 0 0 **4X** 2.65 MAX GAGE 0.41 PLANE С 0.15 SEATING PLANE 0.203 0.30 /В` 0.050 4.70 0.05 **8** ° 4.40 0.45 ⊕|0.13 (M) **0** ° С В 1.60 Α 0.75 SIDE VIEW **DETAILA** NOTES: SCALE 2:1 EXCEPT WHERE NOTED, CONFORMS TO Α. JEDEC DO-214, VARIATION AB ⁄в` DOES NOT COMPLY TO JEDEC STD. VALUE C. ALL DIMENSIONS ARE IN MILLIMETERS DIMENSIONS ARE EXCLUSIVE OF BURRS, D.

- MOLD FLASH, AND TIE BAR PROTRUSIONS. E. DIMENSIONS AND TOLERANCING AS PER ASME Y14.5–2009
- F. LAND PATTERN STANDARD: DIOM7957X241M

 
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